

### **DS3862 Octal High Speed Trapezoidal Bus Transceiver**

### **General Description**

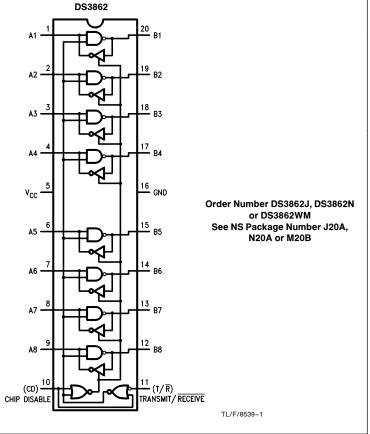
The DS3862 is an octal high speed schottky bus transceiver intended for use with terminated  $120\Omega$  impedance lines. It is specifically designed to reduce noise in unbalanced transmission systems. The open collector drivers generate precise trapezoidal waveforms with rise and fall times of 9 ns (typical), which are relatively independent of capacitive loading conditions on the outputs. This reduces noise coupling to the adjacent lines without any appreciable impact on the maximum data rate obtainable with high speed bus transceivers. In addition, the receivers use a low pass filter in conjunction with a high speed comparator, to further enhance the noise immunity. Tightly controlled threshold levels on the receiver provide equal rejection to both negative and positive going noise pulses on the bus.

The external termination is intended to be a 180 $\Omega$  resistor from the bus to 5V logic supply, together with a 390 $\Omega$  resistor from the bus to ground. The bus can be terminated at one or both ends.

#### **Features**

- Guaranteed A.C. specifications on noise immunity and propagation delay over the specified temperature and supply voltage range
- Temperature insensitive receiver thresholds track bus logic level and respond symmetrically to positive and negative going pulses
- Trapezoidal bus waveforms reduce noise coupling to adjacent lines
- Open collector driver output allows wire-or connection
- Advanced low power schottky technology
- Glitch free power up/down protection on driver and receiver outputs
- TTL compatible driver and control inputs, and receiver outputs
- Control logic is the same as the DS3896

### **Logic and Connection Diagram**



#### **Absolute Maximum Ratings** (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

 Supply Voltage
 6V

 Control Input Voltage
 5.5V

 Driver Input and Receiver Output
 5.5V

 Receiver Input and Driver Output
 5.5V

 Power Dissipation
 1400 mW

 Storage Temperature Range
 -65°C to +150°C

 Lead Temperature (Soldering, 4 seconds)
 260°C

# Recommended Operating Conditions

	Min	Max	Units
Supply Voltage, V <sub>CC</sub>	4.75	5.25	V
Operating Free Air Temperature	0	70	°C

### $\textbf{Electrical Characteristics} \ o^{\circ}\textbf{C} \leq \textbf{T}_{\textbf{A}} \leq \textbf{70}^{\circ}\textbf{C}, \textbf{4.75V} \leq \textbf{V}_{\textbf{CC}} \leq \textbf{5.25V} \ \text{unless otherwise specified (Notes 2 and 3)}$

Symbol	Parameter	Conditions	Min	Тур	Max	Units
Driver an	d Control Inputs:					
$V_{IH}$	Logical "1" Input Voltage		2.0			٧
$V_{IL}$	Logical "0" Input Voltage				0.8	V
II	Logical "1" Input Current	$An = V_{CC}$			1	mA
I <sub>IH</sub>	Logical "1" Input Current	An = 2.4V			40	μΑ
I <sub>IHC</sub>	Logical "1" Input Current	$CD = T/\overline{R} = 2.4V$			80	μΑ
I <sub>IL</sub>	Logical "0" Input Current	An = 0.4V		-1	-1.6	mA
I <sub>ILC</sub>	CD & T/R Logical "0" Input Current	$CD = T/\overline{R} = 0.4V$		-180	-400	μΑ
$V_{CL}$	Input Diode Clamp Voltage	Iclamp = -12 mA		-0.9	-1.5	V
Driver Ou	tput/Receiver Input					
V <sub>OLB</sub>	Low Level Bus Voltage	$An = T/\overline{R} = 2V$ , $Ibus = 100 \text{ mA}$		0.6	0.9	٧
I <sub>IHB</sub>	Logical "1" Bus Current	$An = 0.8V$ , $Bn = 4V$ , $V_{CC} = 5.25V$ and $0V$		10	100	μΑ
I <sub>ILB</sub>	Logical "0" Bus Current	$An = 0.8V, Bn = 0V, V_{CC} = 5.25V $ and $0V$			100	μΑ
$V_{TH}$	Input Threshold	$V_{CC} = 5V$	1.5	1.7	1.9	V
Receiver	Output					
V <sub>OH</sub>	Logical "1" Output Voltage	Bn = 0.9V, $I_{oh} = -400 \mu A$	2.4	3.2		V
V <sub>OL</sub>	Logical "0" Output Voltage	Bn = 4V, I <sub>ol</sub> = 16 mA		0.35	0.5	٧
los	Output Short Circuit Current	Bn = 0.9V	-20	-70	-100	mA
Icc	Supply Current	V <sub>CC</sub> = 5.25V		90	135	mA

Note 1: "Absolute Maximum Ratings" are those beyond which the safety of the device cannot be guaranteed. They are not meant to imply that device should be operated at these limits. The table of "Electrical Characteristics" provide conditions for actual device operation.

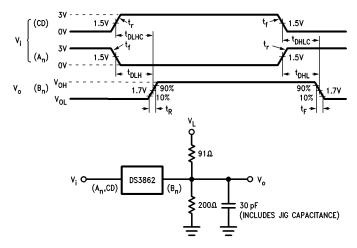
Note 2: All currents into device pins are positive; all currents out of device pins are negative. All voltages are referenced to device ground unless otherwise specified.

Note 3: All typicals are given for  $V_{CC}=5V$  and  $T_{A}=25^{\circ}C$ .

Symbol	Parameter	Conditions	Min	Тур	Max	Units
Driver:					•	
t <sub>DLH</sub>	An to Bn	$CD = 0.8V, T/\overline{R} = 2.0V, VL = 5V$ (Figure 1)		12	20	ns
t <sub>DHL</sub>				12	20	ns
t <sub>DLHC</sub>	CD to Bn	An = $T/\overline{R}$ = 2.0V, VL = 5V, (Figure 1)		12	20	ns
t <sub>DHLC</sub>				15	25	ns
t <sub>DLHT</sub>	T/R to Bn	VCI = An, VC = 5V, (Figure 2) CD = 0.8V, RC = 390Ω, CL = 30 pF RL1 = 91Ω, RL2 = 200Ω, VL = 5V		20	30	ns
t <sub>DHLT</sub>				25	40	ns
t <sub>R</sub>	Driver Output Rise Time	$CD = 0.8V, T/\overline{R} = 2V, VL = 5V$ (Figure 1)	4	9	20	ns
t <sub>F</sub>	Driver Output Fall Time		4	9	20	ns
Receiver:						
t <sub>RLH</sub>	Bn to An	$CD = 0.8V, T/\overline{R} = 0.8V$ (Figure 3)		15	25	ns
t <sub>RHL</sub>				15	25	ns
t <sub>RLZC</sub>	CD to An	Bn = 2.0V, T/ $\overline{R}$ = 0.8V, CL = 5 pF RL1 = 390 $\Omega$ , RL2 = NC, VL = 5V (Figure 4)		15	25	ns
t <sub>RZLC</sub>		Bn = 2.0V, T/ $\overline{R}$ = 0.8V, CL = 30 pF RL1 = 390 $\Omega$ , RL2 = 1.6K, VL = 5V ( <i>Figure 4</i> )		10	20	ns
t <sub>RHZC</sub>		Bn = 0.8V, T/ $\overline{R}$ = 0.8V, VL = 0V, RL1 = 390 $\Omega$ , RL2 = NC, CL = 5 pF( <i>Figure 4</i> )		5	10	ns
t <sub>RZHC</sub>		Bn = 0.8V, $T/\overline{R}$ = 0.8V, $VL$ = 0V, RL1 = NC, RL2 = 1.6K, $CL$ = 30 pF (Figure 4)		8	15	ns
t <sub>RLZT</sub>	T/R to An	$\begin{array}{c} \text{VCI} = \text{Bn, VC} = 3.4\text{V, RC} = 39\Omega \\ \text{CD} = 0.8\text{V, VL} = 5\text{V, RL1} = 390\Omega, \\ \text{RL2} = \text{NC, CL} = 5 \text{ pF} \end{array} \tag{\it Figure 2}$		20	30	ns
<sup>t</sup> RZLT		$ \begin{array}{c} \text{VCI} = \text{Bn, VC} = 3.4\text{V, RC} = 39\Omega, \\ \text{CD} = 0.8\text{V, VL} = 5\text{V, RL1} = 390\Omega, \\ \text{RL2} = 1.6\text{K, CL} = 30  \text{pF} \end{array} $		30	45	ns
t <sub>RHZT</sub>		$\label{eq:VCl} \begin{array}{ c c c c }\hline VCl = Bn, VC = 0V, RC = 39\Omega \\ CD = 0.8V, VL = 0V, RL1 = 390\Omega, \\ RL2 = NC, CL = 5 \ pF & \textit{(Figure 2)} \\ \hline \end{array}$		5	10	ns
<sup>t</sup> RZHT		VCI = Bn, VC = 0V, RC = 39Ω, CD = 0.8V, VL = 0V, RL1 = NC RL2 = 1.6K, CL = 30 pF (Figure 2)		10	20	ns
t <sub>NR</sub>	Receiver Noise Rejection	(Figure 5)	9	12		ns

Note: NC means open

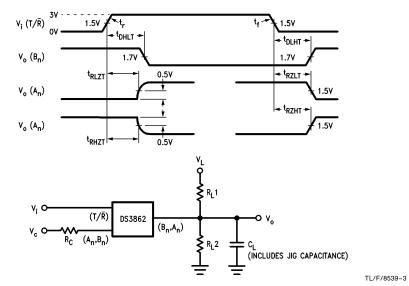
### **Switching Waveforms**



Note:  $t_r = t_f \le 5$  ns from 10% to 90%

FIGURE 1. Driver Propagation Delays

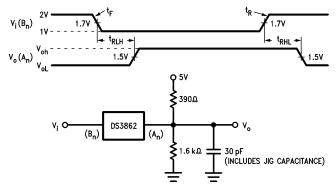
TL/F/8539-2



Note:  $t_{\text{f}}\,=\,t_{\text{f}}\,\leq\,5$  ns from 10% to 90%

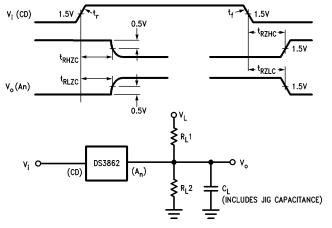
FIGURE 2. Propagation Delay From  $T/\overline{R}$  Pin to An or Bn.

# Switching Waveforms (Continued)



Note:  $t_R = t_F \le$  10 ns from 10% to 90%

FIGURE 3. Receiver Propagation Delays



Note:  $t_{\text{r}} = t_{\text{f}} \le$  5 ns from 10% to 90%

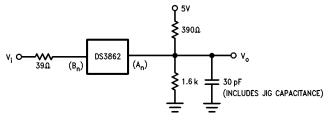
FIGURE 4. Propagation Delay From CD Pin to An

TL/F/8539-4

TL/F/8539-5

# Switching Waveforms (Continued)

$$v_{i}^{2.5V} = 1.7V$$
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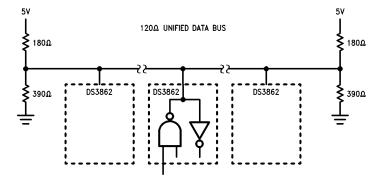
Note:  $t_r = t_f = 2$  ns from 10% to 90%

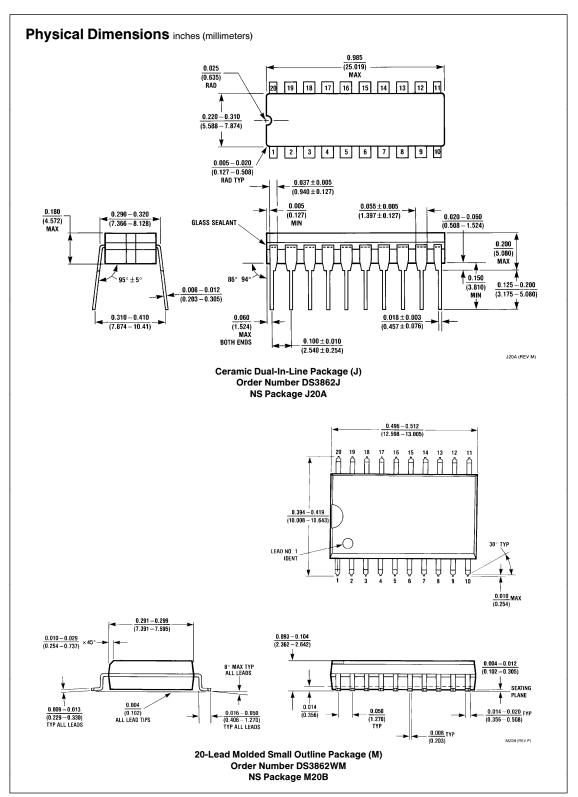
FIGURE 5. Receiver Noise Immunity: No Response at Output Input Waveform.

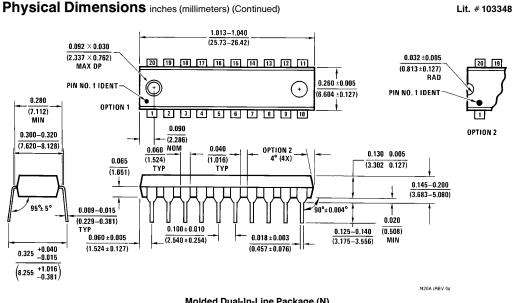
TL/F/8539-6

TL/F/8539-7

### **Typical Application**







Molded Dual-In-Line Package (N) Order Number DS3862N NS Package N20A

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